



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Mostafazadeh et al.

Attorney Docket No.:

NSC1P217D2/NS-3877-2

Application No.: 09/625,071

Examiner: Clark, S.

Filed: July 25, 2000

Group: 2815

Title: LEAD FRAME CHIP SCALE PACKAGE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail to: Commissioner for Patents, Washington, DC 20231 on April 15, 2002.

Signed:

Laura M. Dean

Laura M. Dean

AMENDMENT A TRANSMITTAL

Commissioner for Patents
Washington, DC 20231

Sir:

Transmitted herewith is an Amendment in the above-identified application.

The fee has been calculated as shown below.

	Claims After Amendment		Highest Previously Paid For	Present Extra	Small Entity Rate Fee	Large Entity Rate Fee
Total Claims	31	MINUS	34	00	x 9 =	x 18 =
Independent Claims	8	MINUS	7	1	x 420 =	x 84 = 84.00
Multiple Dependent Claim Present and Fee Not Previously Paid					\$140.00	\$280.00
Total					\$	\$84.00

- ☒ Applicant(s) hereby petition for a 1 month extension(s) of time to respond to the aforementioned Office Action.
- ☒ Applicant(s) believe that no (additional) Extension of Time is required; however, if it is determined that such an extension is required, Applicant(s) hereby petition that such an extension be granted and authorize the Commissioner to charge the required fees for an Extension of Time under 37 CFR 1.136 to Deposit Account No. 500388.
- ☒ Enclosed is our Check No. 14741 in the amount of \$194.00 to cover the additional claim fee and/or extension of time fees.
- ☒ Please charge the required fees, or any additional fees required to facilitate filing the enclosed response, to Deposit Account No. 500388 (Order No. NSC1P217D2).

04/25/2002 SSITHIB1 00000014 09625071

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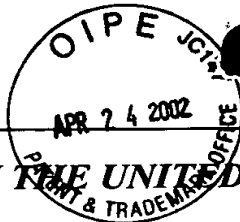
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Respectfully submitted,
BEYER WEAVER & THOMAS, LLP

Steve D Beyer
Steve D Beyer

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PATENT

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail to: Commissioner for Patents, Washington, DC 20230 on April 15, 2002.

Signed: _____

Laura M. Dean

AMENDMENT A

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated 3 January 2002, the period for response to which extends through April 3, 2002, please amend the above-identified patent application as follows:

In The Drawings

Proposed corrections to the drawings accompany this response. The proposed changes are marked in red on the original drawings. It is noted that the changes merely remove the "Prior Art" label from Figs. 1a, 1b and 1c of this application

In The Specification

Please **delete** the first paragraph of the "Related Art" section of the application that begins on page 1, line 14 and ends on page 2, line 9.

Please **replace** the first paragraph of the Detailed Description section of the application, beginning on page 4, line 13 and continuing to page 5, line 7 of the specification with the following three **amended** paragraphs. It is noted that the first paragraph being inserted is taken primarily from the former first paragraph of the "Related Art" that was deleted, the second

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